

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Attn: APPLICATION BRANCH**
Atsushi YAMAGUCHI et al. : **Attorney Docket No. 2003_1311**
Serial No. NEW :
Filed September 24, 2003 :

**PROCESS AND APPARATUS FOR
FLOW SOLDERING
(Rule 1.53(b) Divisional
of Serial No. 09/924,555,
Filed August 9, 2001)**

THE COMMISSIONER IS AUTHORIZED
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CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
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Alexandria, VA 22313-1450

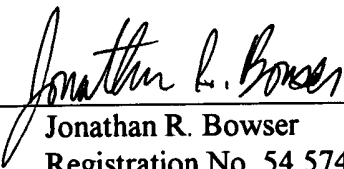
Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 2000-249588, filed August 21, 2000, as acknowledged in the Declaration of this application.

A certified copy of said Japanese Patent Application is of record in parent application Serial No. 09/924,555, filed August 9, 2001.

Respectfully submitted,

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September 24, 2003